

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

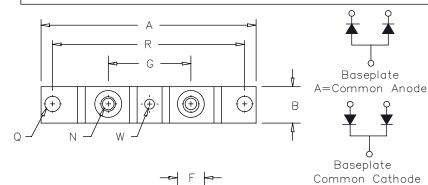
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Schottky PowerMod



U

Dim. Inches		Millimeters		
Min.	Max.	Min.	Max.	Notes
B 0.700 C E 0.120 F 0.490	0.130 0.510	 17.78 3.05 12.45	92.20 20.32 16.00 3.30 12.95	
G 1.375 H 0.010	5 BSC 	34.92 0.25	BSC 	
N Q0.275	0.290	 6.99	 7.37	1/4-20 Dia.
R 3.15 U 0.600	0 BSC	80.01 15.24	BSC 	
V 0.312 W 0.180	 0.195	7.92 4.57	 4.95	Dia.

Notes: Baseplate: Nickel plated copper; common cathode

Baseplate D=Doubler

Microsemi	Working Peak	Repetitive Peak
Catalog Number	Reverse Voltage	Reverse Voltage
CPT30120*	20V	20V
CPT30125*	25V	25V
CPT30130*	30V	30V
CPT30135*	35V	35V
CPT30140*	40V	40V
CPT30145*	45V	45V
*Add Suffix	A for Common Anod	e, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring Protection
- Common Cathode Center Tap
- 300 Amperes/45 Volts
- 125°C Junction Temperature
- Reverse Energy Tested
- VRRM 20 45 Volts
- ROHS Compliant

Electrical Characteristics

 $^{T}\!C=71^{\circ}C,$ Square wave, $^{R}\!\theta JC=0.20^{\circ}C/W$ $^{T}\!C=71^{\circ}C,$ Square wave, $^{R}\!\theta JC=0.40^{\circ}C/W$ 8.3ms, half sine, $^{T}\!J=125^{\circ}C$ F(AV) 300 Amps F(AV) 150 Amps Average forward current per pkg Average forward current per leg IFSM 2000 Amps Maximum surge current per leg Maximum repetitive reverse current per leg |R(OV) 2 Amps Max peak forward voltage per leg VFM 0.62 Volts $f = 1 \text{ KHZ}, 25^{\circ}\text{C}$ $I \text{ FM} = 200 \text{A:} \text{TJ} = 25^{\circ}\text{C*}$ ٧FM Max peak forward voltage per leg IFM = 200A:TJ = 125°C* V_{FM} 0.58 Volts Max peak forward voltage per leg V_{RRM} , $T_{J} = 125$ °C* ^IRM Max peak reverse current per leg 2 Amps VRRM, TJ = 25°C IRM Max peak reverse current per leg 4.0 mA 5500 pF $V_R = 5.0 V.^T C = 25 °C$ Typical junction capacitance *Pulse test: Pulse width 300 µsec, Duty cycle 2%

Thermal and Mechanical Characteristics

www.microsemi.com

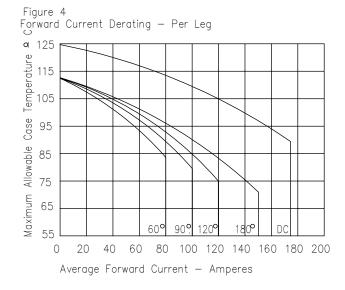
Storage temp range ^TSTG -40°C to 150°C ΤJ Operating junction temp range -40°C to 125°C R OJC 0.40°C/W Junction to case 0.08°C/W Case to sink Max thermal resistance per leg R ocs Typical thermal resistance Terminal Torque 35-40 inch pounds 30-40 inch pounds Mounting Base Torque (outside holes) Mounting Base Torque (center hole) 8-10 inch pounds center hole must be torqued first Weight 2.8 ounces (75 grams) typical

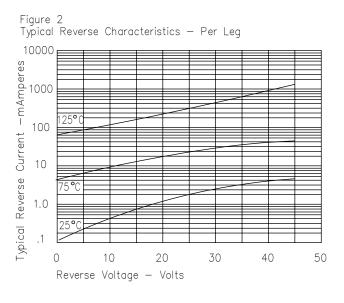


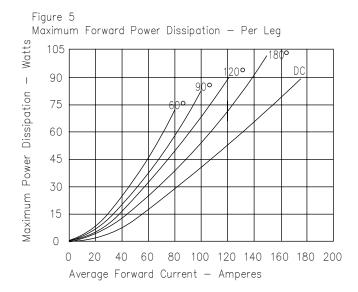
CPT30120 - CPT30145

Figure 1 Typical Forward Characteristics — Per Leg 1000 800 600 400 200 100 80 60 40 Amperes 20 10 Instantaneous Forward Current 8.0 6.0 4.0 2.0 1.0 0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 Instantaneous Forward Voltage - Volts

Figure 3 Typical Junction Capacitance - Per Leg 100000 40000 ЬР 20000 Capacitance 10000 6000 4000 Junction 2000 1000 .2 .5 2 5 20 .1 10 50 100 Reverse Voltage - Volts









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